


Chokes for Power Lines

Material Data Sheet

Product Class:	Ring Core Double Choke B82725S2602N041	
Date	26.07.2021	
IMDS ID if available		
Version:	02	

Product Part (IMDS: semi component)	Material Class (IMDS: Material)	Material (Classification) VDA 231	Substance	TMPS** [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)
Active Part	Ceramic	4B	Manganese Zinc Ferrite	100	12645-49-7	58.8	
	Duromer	2C	Epoxy (EP)	100	25068-38-6	1.2	
	Heavy Metal	1C	Cu	100	7440-50-8	33	
	Duromer	2C	Polyurethane (PUR)	100	68400-67-9	0.7	
Encapsulation and Mounting	Thermoplastic	2A	Polycarbonate (PC)	89.8	25971-63-5	3.6	
			Glass fiber	10	65997-17-3		
			PFBS	0.2	29420-49-3		
	Thermoplastic	2A	Polyethylene terephthalate (PET)	100	25038-59-9	0.4	
	Thermoplastic	2A	Polyamide (PA)	100	628-02-4	1.7	
Thermoplastic	2C	Polyurethane (PUR)	100	68400-67-9	0.4		
Termination	Heavy Metal	1C	Sn	100	7440-31-5	0.1	
Label	Polymer	2C	Polyethyleneterephthalate (PET)	100	25038-59-9	0.1	
	Polymer	2C	Acrylic resin	100	37325-11-4		X
Sum in total:						100.0	

Size W x L x H [max. in mm] 20.5 x 40.4 x 41	Weight [approx. in g] 48	Part Number B82725S2602N041
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Not part of a Product Class		
Contact	Dr. Johann Reindl, MAG EPQM	Important remarks: 1) The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906) Traces are product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise regulated. 2) This Material Data Sheet contains typical values of the respective products set forth herein. We expressly point out that all values and statements contained herein are based on our best present knowledge and cannot be regarded as binding statements or binding product specifications, unless otherwise explicitly agreed in writing. TDK ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE.
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*) others: (not declarable or prohibited substances acc. GADSL)		
**) typical mass percentage of substance		

The products set forth herein are "RoHS-compatible". RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

RoHS - Exemptions for the Product Class / Product according to Annex III: (<input checked="" type="checkbox"/> valid <input type="checkbox"/> not valid) <input checked="" type="checkbox"/> no exemptions; <input type="checkbox"/> Exemption 6 (a): Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0,35 % lead by weight; <input type="checkbox"/> Exemption 6 (b): Lead as an alloying element in aluminium containing up to 0,4 % lead by weight; <input type="checkbox"/> Exemption 6 (c): Copper alloy containing up to 4 % lead by weight; <input type="checkbox"/> Exemption 7 (a): Lead in high melting temperature type solder (i.e. lead-based alloys containing 85 % by weight or more lead); <input type="checkbox"/> Exemption 7 (c)-I: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectric devices, or in a glass or ceramic matrix compound; <input type="checkbox"/> Exemption 7 (c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher; <input type="checkbox"/> Exemption 7 (c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC; <input type="checkbox"/> Exemption 15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages; <input type="checkbox"/> Other Exemption than above
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